

# Fabrication of swelling structure on SiC surface by using multi-charged Ar beam

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## Abstract :

Silicon carbide (SiC) crystal, which has good mechanical and electric properties, is one of hopeful materials. Owing to its ultrahigh-hardness and chemical stability, it is difficult to fabricate structures in micro-nano meter scale by means of conventional fabrication processes. In previous experiments, a swelling structure, which is fabricated by means of ion-beam induced expansion effect, has been observed for SiC crystal ([1], [2]). The object of the present study is to show a feasibility of ion-beam induced swelling effect as a fabrication method for SiC crystal. Based on the experimental results, a fabrication of multi-step structure on SiC crystal has been demonstrated.

Ar-beam, which was prepared by ECR ion source (10GHz-NANOGAN), was irradiated on 6H-SiC crystal and a swelling height was observed. By using Ar<sup>7+</sup> beam with 700 keV, the maximum height of 100nm was obtained. Based on those results, two-step structure has been successfully fabricated by the two-step irradiation. In order to confirm the possibility of the swelling structure as mechanical devices, irradiation-induced modification of mechanical properties of SiC crystal was evaluated by means of nano-indentation method. No serious deteriorations have been observed under the present irradiation conditions.

## Advantages of SiC crystal

- High-power devices available at high temperature
- High mechanical strength  
Hardness : 55 GPa / Young's modulus 600~620 GPa<sup>6)</sup>
- Price is decreasing  
Development of synthesis process for mass production of high-power semiconductor devices would reduce in price.

Properties	Si	4H-SiC	GaAs	GaN
Crystal Structure	Diamond	Hexagonal	Zincblende	Hexagonal
Energy Gap : $E_G$ (eV)	1.12	3.26	1.43	3.5
Electron Mobility : $\mu_n$ (cm <sup>2</sup> /Vs)	1400	900	8500	1250
Hole Mobility : $\mu_p$ (cm <sup>2</sup> /Vs)	600	100	400	200
Breakdown Field : $E_B$ (V/cm) X10 <sup>6</sup>	0.3	3	0.4	3
Thermal Conductivity (W/cm <sup>2</sup> °C)	1.5	4.9	0.5	1.3
Saturation Drift Velocity : $v_s$ (cm/s) X10 <sup>7</sup>	1	2.7	2	2.7

[http://rohms.rohm.com/en/products/databook/applinote/discrete/sic/common/sic\\_appli-e.pdf](http://rohms.rohm.com/en/products/databook/applinote/discrete/sic/common/sic_appli-e.pdf)

IB-induced swelling structure caused by volume expansion

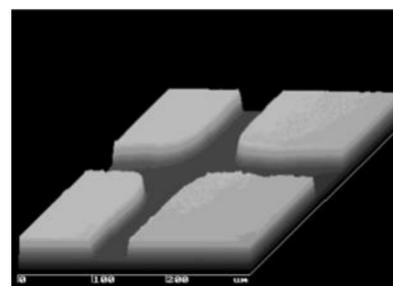


Fig. 2 Swelling structures formed on beta-SiC irradiated by Ni (4 MeV) <sup>7)</sup>

Large volume swelling : Max. 8~20% <sup>8)</sup>

## Highly charged ion beam facility @ KUT

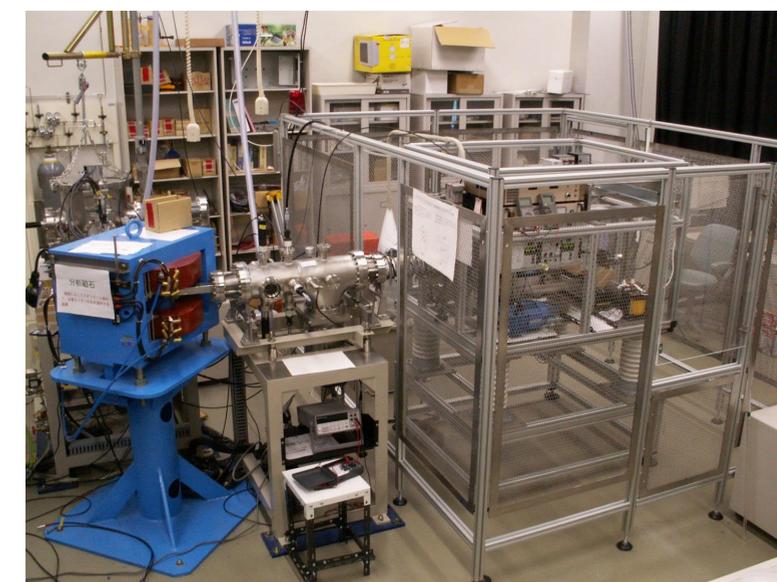


Fig. 3 HCI beam facility built at Kochi Univ. of Tech. <sup>9)</sup>  
The facility includes an ECRIS, an acceleration system up to 130 kV, a transport and analysis, and an irradiation system.

$$P_{RF} = 0 \sim 80 \text{ W}$$

$$V_{ext.} = 0 \sim 30 \text{ kV}$$

$$V_{accl.} = 0 \sim 100 \text{ kV}$$

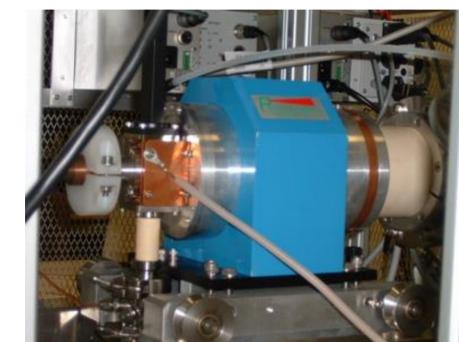


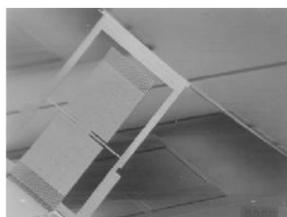
Fig. 4 ECRIS for multiple-charged ion beams  
A 10 GHz NANOGAN, which is an ECRIS developed by PANTECHNIK Co., was installed.

## Expanding application of 3D structure in micro-nano meter scale



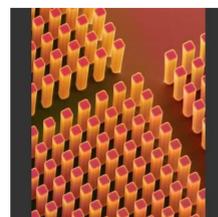
MEMS

Linear rack gear reduction drive<sup>3)</sup>



Optoelectronics

Self-Assembled Electrostatic Torsion Mirror Microscanners<sup>4)</sup>



Biomedical

DNA purification microchip<sup>5)</sup>

Fig. 1 Examples of products with 3D structure in micro-nano meter scale

## Irradiation of Ar-beam on SiC

Ar-beam was irradiated through a stencil mask.

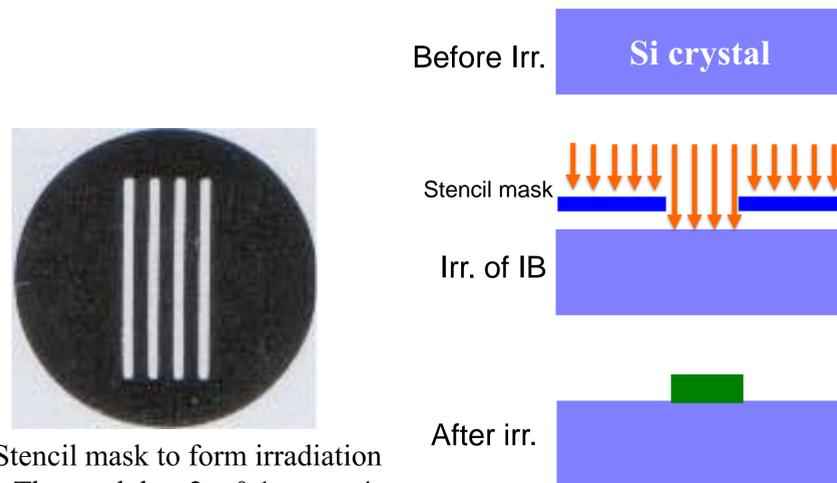
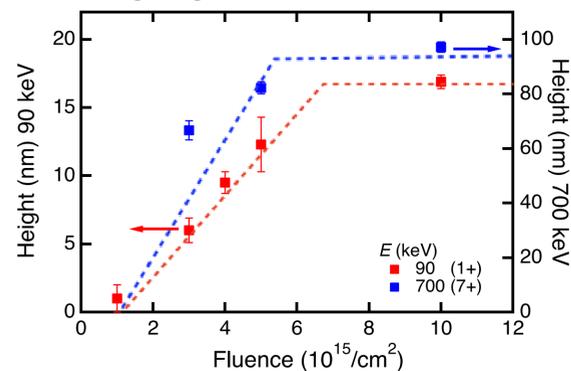


Fig. 5 Stencil mask to form irradiation pattern. The mask has 2 x 0.1 mm x 4 slits.

Fig. 6 Procedure to form swelling structure

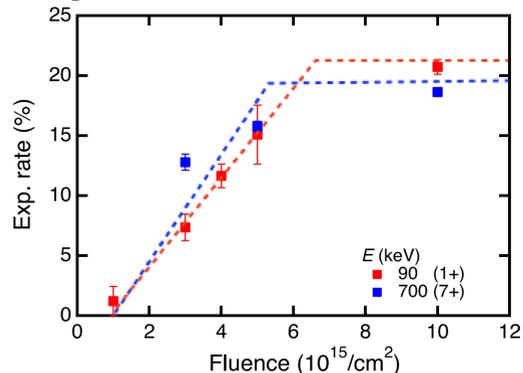
## Swelling induced by Ar-beam irradiation

Fig. 7 Swelling height vs. fluence



- Swelling str. grow with fluence up to  $n = 5\text{--}6 \times 10^{15} / \text{cm}^2$ .
- Swelling height @  $10 \times 10^{15} / \text{cm}^2 = 17 \text{ nm}$  (90 keV)  
97nm (700 keV)

Fig. 8 Expansion rate vs. fluence



- Energy dependence is small.
- Max. expansion rate ~ 20%

## 2-step irradiation

Fig. 9 Orientation of stencil mask for 2-step irradiation  
1st irradiation      2nd irradiation

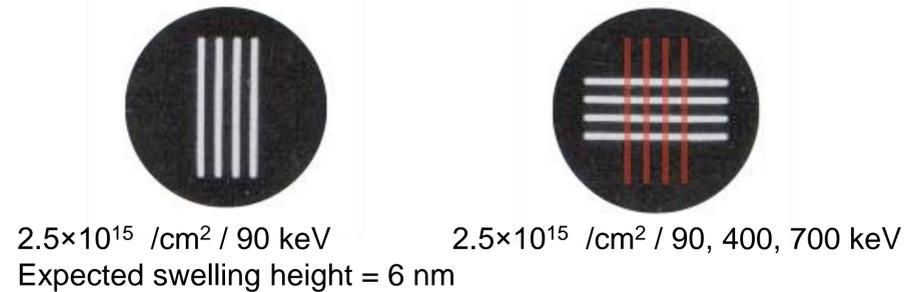
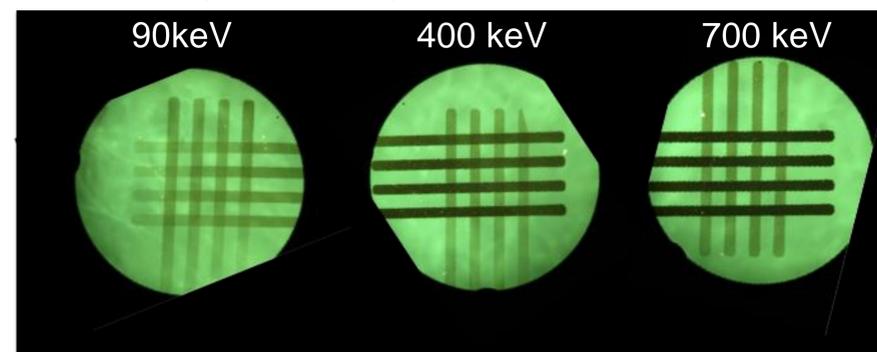
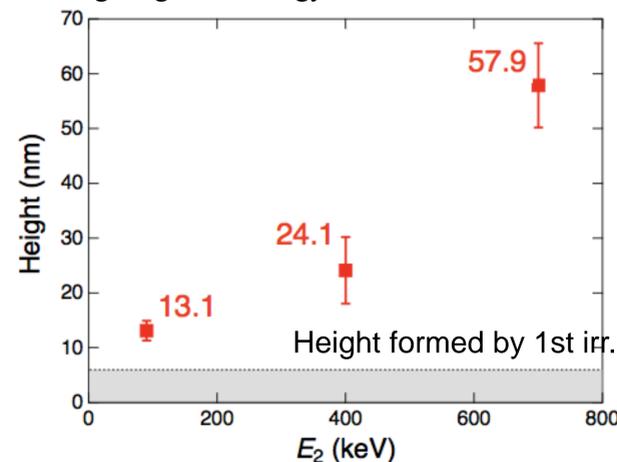


Fig. 10 Photoimages of SiC after 2nd irradiation



## Swelling height formed by 2-step irradiation

Fig. 11 Swelling height vs. energy of Ar-beam for 2nd irradiation



- Additional swelling, observed at overlap, increases with beam energy of 2nd irradiation.
- Swelling height, fabricated by sequential irradiation, is consistent with sum of those by each irradiation. However, an ambiguity in observed swelling height remains.

## Modification of mechanical properties

Fig. 12 Nano-hardness and Young's modulus measured by means of nano-indentation method

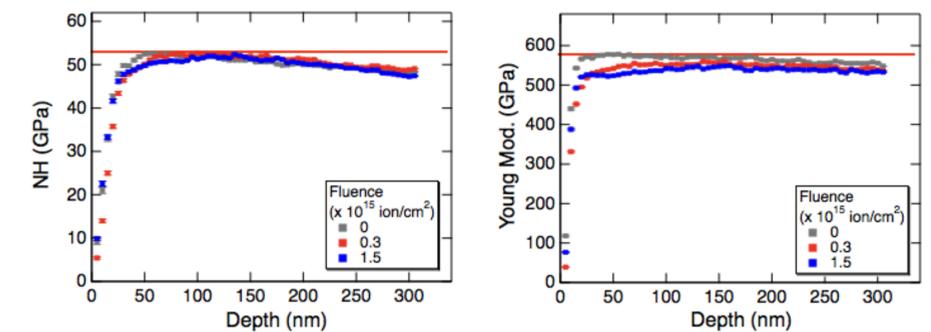
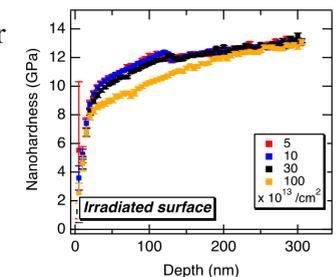


Fig. 13 Nano-hardness of Ar beam-irradiated Si



- Relative deterioration in nano-hardness of SiC crystal, induced by Ar-beam irradiation, is ~ 5%.
- SiC crystal keeps high mechanical property against Ar-beam irradiation compared with Si crystal.

## Conclusions

- 1) Swelling structures with the height ~100 nm was formed on SiC crystal by irradiation of Ar<sup>7+</sup> beams ( $100 \times 7 \text{ keV}$ ,  $5 \times 10^{15} / \text{cm}^2$ ).
- 2) 2-step swelling structures were successfully fabricated through 2-step irradiation method.
- 3) Swelling structure on SiC crystal would be good candidate to apply as mechanical elements in micro-nano meter scale.

## References

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